

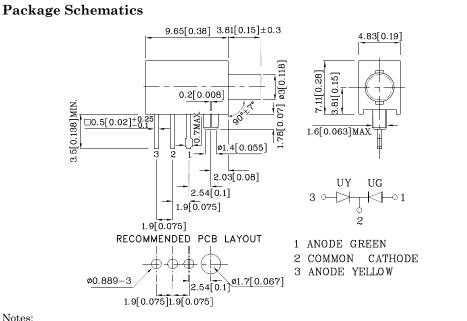
Part Number: XWP1SUGY93M

3mm RIGHT ANGLE LED INDICATOR

Features

- Housing material: Type 66 Nylon
- Black casing provides superior contrast
- Housing UL rating: 94V-0
- Reliable & robust
- Custom color combinations available
- RoHS Compliant





Notes:

1. All dimensions are in millimeters (inches).

2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		UG (GaP)	UY (GaAsP/ GaP)	Unit	
Reverse Voltage	$V_{\rm R}$	5	5	V	
Forward Current	$\mathbf{I}_{\mathbf{F}}$	25	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\rm FS}$	140	140	mA	
Power Dissipation	$\mathbf{P}_{\mathbf{D}}$	62.5	75	mW	
Operating Temperature	TA	-40 ~	°C		
Storage Temperature	Tstg	-40 ~			
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds				
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds				

Operating Characteristics (T _A =25°C)	UG (GaP)	UY (GaAsP/ GaP)	Unit	
Forward Voltage (Typ.) (I _F =20mA)	$V_{\rm F}$	2.2	2.1	v
Forward Voltage (Max.) (I _F =20mA)	$V_{\rm F}$	2.5	2.5	v
Reverse Current (Max.) (V _R =5V)	I_{R}	10	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =20mA)	λP	565*	590*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =20mA)	λD	568*	588*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$ riangle \lambda$	30	35	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	15	20	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I _F =20mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XWP1SUGY93M	Green	GaP	White Diffused -	4*	9*	565*	100°
	Yellow	GaAsP/GaP		2*	5*	590*	

*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

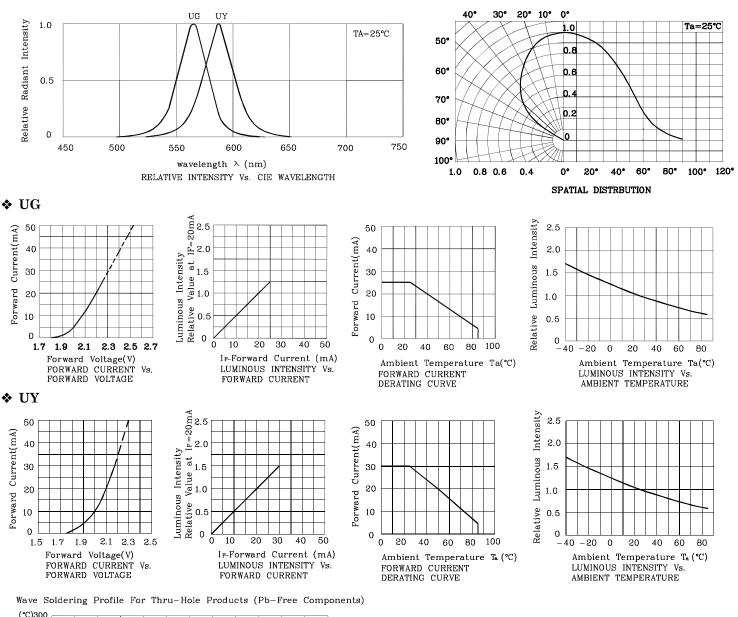
Dec 25,2013

XDSA2770 V8-Z Layout: Maggie L.





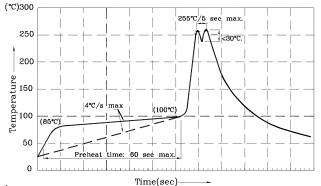
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Remarks:

1. Wavelength: +/-1nm

3. Forward Voltage: +/-0.1V



Notes:

Notes:
1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec
(5 gas max)

- (5 sec max).
- (a) See final).
 (b) see final).
 (c) apply stress to the epoxy resin while the temperature is above 85°C.
 (c) Fixtures should not incur stress on the component when mounting and during soldering process.
 (c) Constraints of the stress of t

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If special sorting is required (e.g. binning based on forward voltage,

luminous intensity / luminous flux, or wavelength),

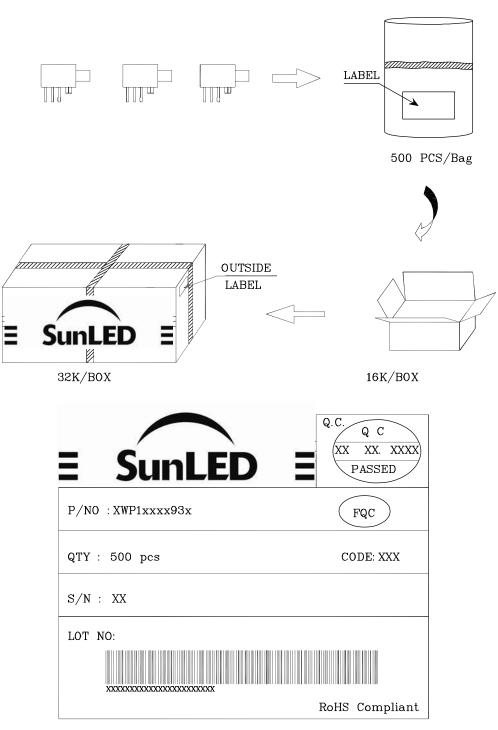
2. Luminous Intensity / Luminous Flux: +/-15%

the typical accuracy of the sorting process is as follows:

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at http://www.SunLEDusa.com/TechnicalNotes.asp